



**Product data sheet** 

#### **1. General description**

AC Thyristor power switch in a SOT223 surface-mountable plastic package with self-protective capabilities against low and high energy transients.

#### 2. Features and benefits

- · Common terminal on mounting base allows multiple ACTs on shared cooling pad
- Exclusive negative gate triggering
- Full cycle AC conduction
- · Remote gate separates the gate driver from the effects of the load current
- Surface-mountable package
- Very high noise immunity
- Safe clamping of low energy over-voltage transients
- · Self-protective turn-on during high energy voltage transients

#### 3. Applications

- Contactors, circuit breakers, valves, dispensers and door locks
- Fan motor circuits
- Lower-power highly inductive, resistive and safety loads
- Pump motor circuits

#### 4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{\text{DRM}}$	repetitive peak off-state voltage		-	-	600	V
I <sub>T(RMS)</sub>	RMS on-state currentfull sine wave; $T_{sp} \le 112 \text{ °C}$ ; Fig. 1;Fig. 2; Fig. 3		-	-	0.8	A
I <sub>TSM</sub>	non-repetitive peak on- state current	full sine wave; T <sub>j(init)</sub> = 25 °C; t <sub>p</sub> = 20 ms; <u>Fig. 4; Fig. 5</u>	-	-	8	A
		full sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 16.7 ms	-	-	8.8	А
Tj	junction temperature		-	-	125	°C
V <sub>PP</sub>	peak pulse voltage	T <sub>j</sub> = 25 °C; non-repetitive, off-state; <u>Fig. 6</u>	-	-	2	kV
Static cha	aracteristics	· ·				
I <sub>GT</sub>	gate trigger current	V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; LD+ G-; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	1	-	10	mA
		V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; LD- G-; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	1	-	10	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 12</u>	-	9	25	mA
V <sub>T</sub>	on-state voltage	I <sub>τ</sub> = 1.1 A; <u>Fig. 13</u>	-	-	1.3	V
V <sub>CL</sub>	clamping voltage	I <sub>CL</sub> = 0.1 mA; t <sub>p</sub> = 1 ms; T <sub>j</sub> = 125 °C; Fig. 14	650	-	-	V

AC Thyristor power switch

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Dynamic o	characteristics					
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; T <sub>j</sub> = 125 °C; gate open circuit; Fig. 15	1000	-	-	V/µs
dI <sub>com</sub> /dt	rate of change of commutating current	$\label{eq:V_D} \begin{array}{l} V_{\text{D}} = 400 \text{ V};  \text{T}_{\text{j}} = 125 ^{\circ}\text{C};  \text{I}_{\text{T(RMS)}} = 1 \text{ A}; \\ \text{d} \text{V}_{\text{com}}/\text{d} \text{t} = 15  \text{V}/\mu\text{s}; \text{ gate open circuit}; \\ \hline \text{Fig. 16}; \ \hline \text{Fig. 17} \end{array}$	0.3	-	-	A/ms

## 5. Pinning information

Table 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	LD	load						
2	СМ	common						
3	G	gate		G→ <b>q</b> ]→				
4	СМ	common		СМ 001аај924				

### 6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
ACT108W-600E	SOT223	ACT108W-600E,135	Reel	4000	SOT223	16-Mar-2006		

### 7. Marking

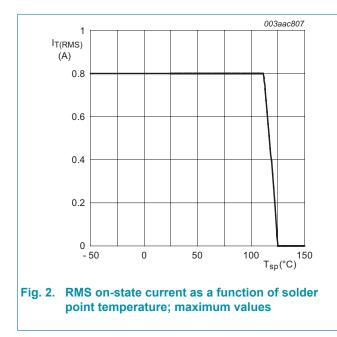
Table 4. Marking codes					
Type number	Marking codes	ng codes			
	Assembly factory: d	Assembly factory: L			
ACT108W-600E	Jdxxx 108W6E	JLxxx 108W6E			

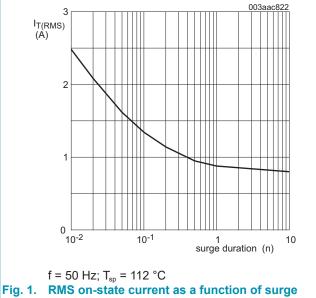
## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

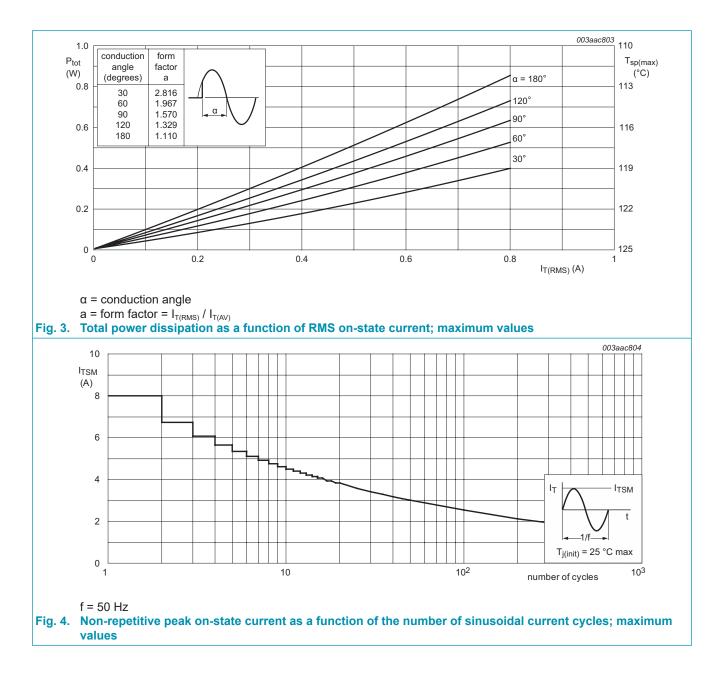
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{\text{DRM}}$	repetitive peak off-state voltage		-	600	V
$I_{T(RMS)}$	RMS on-state current	full sine wave; T <sub>sp</sub> ≤ 112 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	-	0.8	A
I <sub>TSM</sub>	non-repetitive peak on- state current	full sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 20 ms; Fig 4; Fig 5	-	8	A
		full sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 16.7 ms	-	8.8	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; SIN	-	0.32	A <sup>2</sup> s
dl <sub>⊤</sub> /dt	rate of rise of on-state current	I <sub>G</sub> = 20 mA	-	100	A/µs
I <sub>GM</sub>	peak gate current	t = 20 µs	-	1	А
$V_{\text{GM}}$	peak gate voltage	positive applied gate voltage	-	15	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	0.1	W
T <sub>stg</sub>	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C
$V_{PP}$	peak pulse voltage	T <sub>j</sub> = 25 °C; non-repetitive, off-state; <u>Fig. 6</u>	-	2	kV



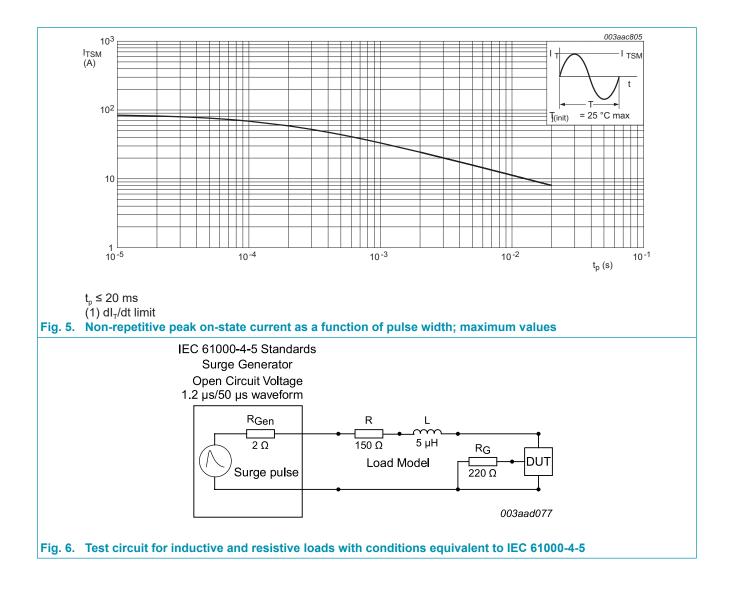




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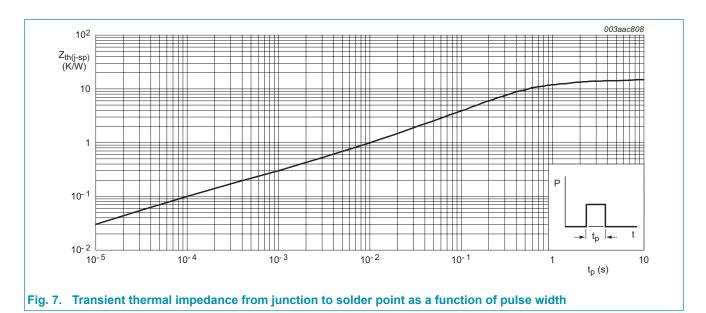


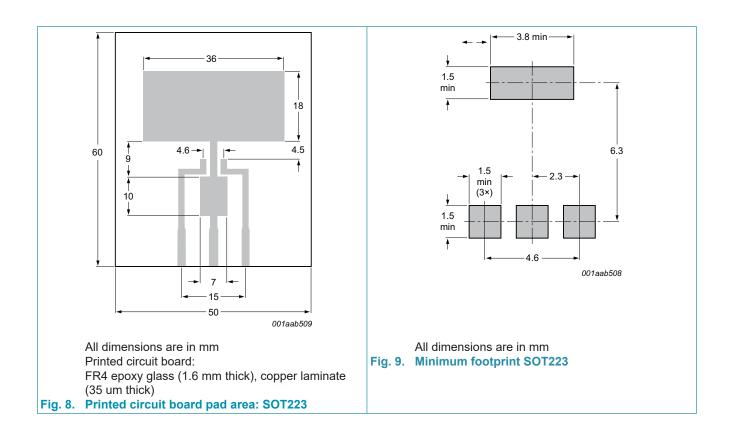
#### ACT108W-600E AC Thyristor power switch



## 9. Thermal characteristics

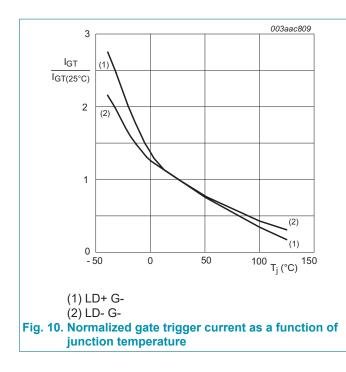
Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point	full cycle with heatsink compound; Fig. 7	-	-	15	K/W
$R_{th(j-a)}$	thermal resistance from junction to	in free air; printed circuit board mounted: minimum pad area; <u>Fig. 8</u>	-	70	-	K/W
	ambient free air	in free air; printed circuit board mounted: minimum footprint; <u>Fig. 9</u>	-	156	-	K/W





### **10. Characteristics**

Table 7. Cl	haracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
I <sub>GT</sub>	gate trigger current	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ LD+ G-};$ $T_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 10}$	1	-	10	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ LD- G-};$ $T_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 10}$	1	-	10	mA
l	latching current	V <sub>D</sub> = 12 V; I <sub>G</sub> = 12 mA; T <sub>j</sub> = 25 °C; <u>Fig. 11</u>	-	-	30	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 12</u>	-	9	25	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 1.1 A; <u>Fig. 13</u>	-	-	1.3	V
V <sub>GT</sub>	gate trigger voltage	$V_{\rm D}$ = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C	-	-	1	V
		V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 125 °C	0.15	-	-	V
I <sub>D</sub>	off-state current	$V_{\rm D} = 600 \text{ V}; \text{ T}_{\rm j} = 25 \text{ °C}$	-	-	2	mA
		V <sub>D</sub> = 600 V; T <sub>j</sub> = 125 °C	-	-	0.2	mA
$V_{\text{CL}}$	clamping voltage	$I_{CL} = 0.1 \text{ mA}; t_p = 1 \text{ ms}; T_j = 125 \text{ °C};$ Fig. 14	650	-	-	V
Dynamic	characteristics					
$dV_{\rm D}/dt$	rate of rise of off-state voltage	$V_{DM}$ = 402 V; T <sub>j</sub> = 125 °C; gate open circuit; Fig. 15	1000	-	-	V/µs
dI <sub>com</sub> /dt	rate of change of commutating current	$V_{D} = 400 \text{ V};  \text{T}_{\text{j}} = 125 ^{\circ}\text{C};  \text{I}_{\text{T(RMS)}} = 1 \text{ A}; \\ \text{d} \text{V}_{\text{com}}/\text{d} \text{t} = 15 \text{ V}/\mu\text{s}; \text{ gate open circuit}; \\ \overline{\text{Fig. 16}; \text{ Fig. 17}}$	0.3	-	-	A/ms



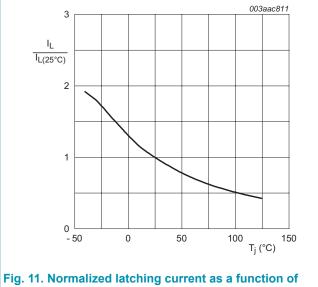
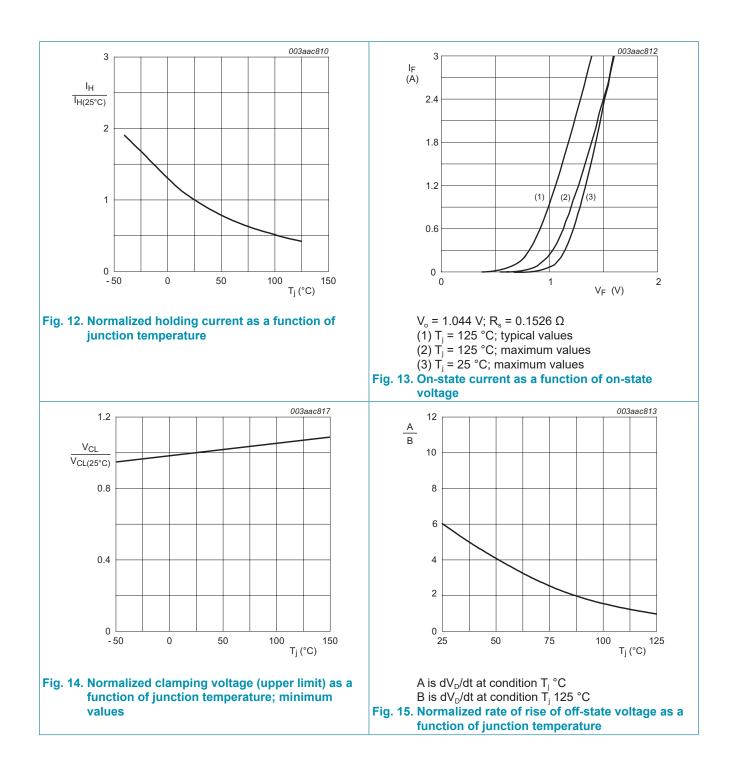
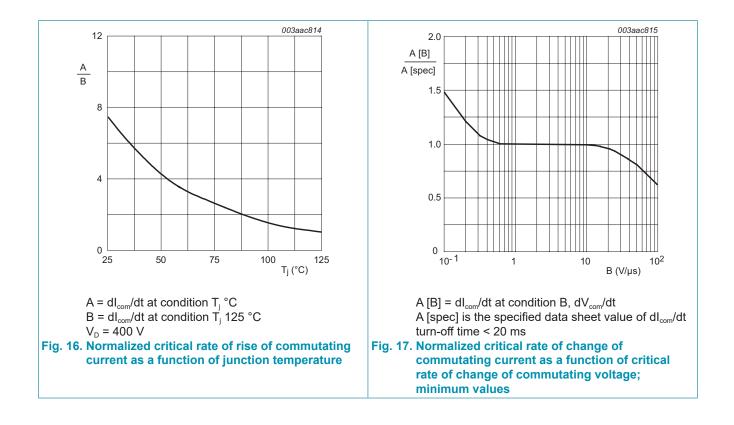


Fig. 11. Normalized latching current as a function of junction temperature

ACT108W-600E AC Thyristor power switch

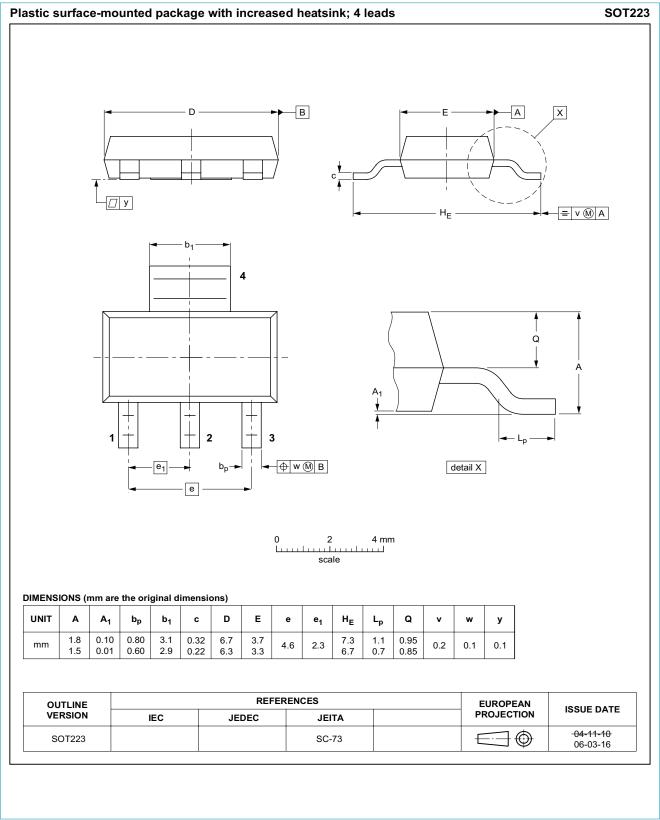


ACT108W-600E AC Thyristor power switch



#### **11. Package outline**

#### Assembly factory: d & L



### 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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